<sup>亠</sup>东东溢新材料科技有限公司

GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.

# 品质承认书 Quality specification

客户 Customer:

供应商:广东东溢新材料科技有限公司

Supplier: GUANGDONG DONGYI HIGH-TECH MATERIAL SCIENCE&TECHNOLOGY CO., LTD.

产品类型 Product type: 散热纯胶膜 Thermal conductivityBonding Sheet

材料品名 Material name: PS-S

编号 No:063 版本 Ver: A3

制作日期 Date of production:2024/04/11

客户确认 Customer:

采购 Purchase:	品质 Quality:	工程 Engineering:
职务 Position:	职务 Position:	职务 Position:

备注 Note:(盖章 Seal)

广东东溢新材料科技有限 GUANGDONG DONGYI HIGH-		FECHNOLOGY CO., LTD.
业务 Marketing: 赵礼雄	品质 Quality:陈伟志	技术 Technical:侯松斌
职务 Position:总监	职务 Position:经理	职务 Position:经理
备注 Note: (盖章 Seal)	The	
	X	

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东东溢新材料科技有限公司

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### 产品名称 Product name

R

東溢

DONGYI

序号	东溢型号	胶厚(um)	包装规格
No	DY model	AD Thickness	Packaging
1	PS25-250S (F)	25	250mm*200m
2	PS25-500S (F)	25	500mm*100m
3	PS50-250S(F)	50	250mm*200m
4	PS50-500S(F)	50	500mm*100m

# 

### ●产品结构 Product Structure



### ●编码原则 Product coding principle

品名示意图如下 The diagram as follows:

XX – XXX

PS

注:□:表示英文字母 English alphabet; x: 阿拉伯数字 Arabic numeral.

涂布基材类型 Coatedfilm type: F:离型膜 Release film

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胶系类别 Adhesive type: S

幅宽 Width: 250=250mm 500:500mm

胶膜厚度 Adhesive Thickness:50:50 μm

热固型纯胶膜代号 Bonding Sheet code:PS

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●物性指标 General Properties
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序号 Item	性能项目 Test Item	单位 Unit	测试条件 TestCondition	标准 Standard	测试方法 Test Method
1	厚度 Thickness	um	A	$\pm 5$	东溢规范 DongyiMethod
2	幅宽 Width	mm	А	标准 Standard+2/-0	东溢规范 DongyiMethod
3	剥离强度 Peel Strength	kgf/cm	А	≥1.0	IPC-TM-650-2.4.9
4	耐化学品性 Chemical Resistance	%	HCl&NaOH 2mol/L	≦20	IPC-TM-650-2.3.2
5	焊锡耐热性 Solder Resistance		288°C/10S	无分层、起泡 No delamination, sparkling	IPC-TM-650-2.4.13
6	体积电阻 Volume resistivity	$\Omega$ -cm	1000V	$>2.0\times10^{12}$	IPC-TM-650 2.5.17
7	表面电阻 Surface resistance	Ω	1000 V	>2.0×10 <sup>11</sup>	IF C-1WI-050 2.5.17
8	导热系数 Thermal conductivity	W/m.K	А	$1.0 \pm 0.2$	ASTM D 5470
9	溢胶量 Resin Flow	mm	180°C/10s /100kgf/90s	≦1.0	IPC-TM-650-2.3.17.1

注 Note: A 代表常态"A" Means normal。

铜箔与铝箔贴合时, 剥离强度≥1.0 N/mm。Copper foil is bonded with aluminum foil, peeling strength more than or equal to 1 N/mm.

### ▶ 外观管控 Appearance requirement

异常类型 Exception classes	异常大小 Abnormal size	允许个数 Allowed value(250*400mm)
杂质 Impurity	0.1~0.	5mm ≦8 个 dots
垫伤 Pad injury		$mm  \leq 1 \uparrow dots$
气泡 Bubble	$\geq 1$ mm	不允许 Not allowed
接头 Joint		≦3↑

注 Note: 产品边缘 3mm 以内异常, 不作管控要求 From the product within 3 mm of the edge of exception, don't do control requirements。

### ●储存 Storage

温度<10℃、湿度<70% RH、真空包装、无腐蚀性气体的室内,制造日期后保存3个月。Temperature<10℃, humidity < 70% RH, airproof vacuumedpackaging, no corrosive gas chamber for 3 months。

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### ●包装 Packing

1. 每一卷成品用纸管卷取。每批出货的每个规格提供一份品质检验报告 Each volume of finished paper tube winding。

2. 每一卷成品用纸箱包装, 避免在运输上碰撞。产品采用防潮、干燥、密封 包装, 成卷装入纸箱 Each volume of finished carton packaging, in the transport collision avoidance. Products using moistureproof, dry, sealed packaging, rolls into cartons。

3. 包箱标签 Package box label

无卤标签 Halogen free label: 环保标签 Green label: 合格标签 Inspection tag:



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注 Note: 以上建议压合参数,鉴于各厂家机台及生产工艺差异,故仅供参考。建议 尽量使用传统压合工艺。Customers can according to their own technology, equipment conditions and performance requirements, through the test to determine the appropriate operating conditions. It is recommended that the traditional pressing process be used as far as possible.

#### ●使用注意事项 Matters needing attention

1. 如产品被放置在低于 10 度以下储存环境,建议客户在使用前将产品静置 4 小时 以上回暖直至产品温度回升至室温温度(20--30℃)后方才使用、以确保最佳产品 使用特性,同时也应避免放置在阳光直接照射及高温环境下 if product was placed in under Temperature 10℃for storage, the product should be placed in the room temperature20~30℃ more than 4 hoursbefore using, in order to make the product temperature up to 20~30℃, to ensure the best product features. At the same time should also avoid placing it in direct sunlight and high temperature environment.

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2. 在背胶前,如接触界面做表面清洁,须保证接触界面干燥及不残留溶剂(如酸碱、 油污等)。Before lamination, such as contact interface makes the surface cleaning, must also ensure that the contact interface and not dry residual solvents (such as acid and alkali, oil etc.).

3. 此规格书中表述的所有测试数据以及建议之工艺条件和参数仅供参考,产品使用 方需要按照自身实际生产设备及产品要求等因素自行确认最优生产工艺及作业参数。 特此声明!

Hereby declared that all test data and recommended process conditions and operating parameters presented in this technical datasheet are for informational purposes only. Product users need to confirm the optimal production process and operating parameters according to their actual production equipment and product requirements.

#### ●物性测试方法 PropertiesTest Method

#### 剥离强度检验方法 Peel Test Method

1、范围 The range:

本检验方法适用本公司纯胶产品剥离强度之量测。This test method for bonding sheetmeasurement of peel strength.

2、检测仪器 Testing instruments:

剥离强度测试仪 Peel strength testing instruments

3、样品制作 The sample:

a) 切取取 10Z 铜箔 10cm×10cm 大小,切取一块大小相同的纯胶膜,先铜箔 粗糙面进行贴合,放在 120℃过塑机上过一遍,裁切 1cm 宽,冷却后撕掉涂胶基 材。取一块铝箔与上面 1cm 宽样品贴合,再放在 120℃过塑机上过一遍。The size of 10Z copper foil 10cm × 10cm was cut and a piece of pure rubber film of the same size was cut. The rough surface of copper foil was first bonded and placed on a 120 °C overplasticizer. The width of 1cm was cut and the coating substrate was torn off after cooling. Take a piece of aluminum foil and attach it to a wide sample of 1cm on top, and put it on a 120 °C plasticizer.

b)快压:温度180℃、压力100kgf/cm2、预热10s、成型90s;熟化:160 ℃ × 60min; Quick pressure: temperature 180℃, pressure 100 kgf/cm2, Time10 s, 90 s; Cure: 160 ℃ x 60 min.

4、样品测试The sample test:

a) 取熟化过后之样片,把样品铝箔面用双面胶固定在测试仪的滚轮上,用 夹具夹住铜箔一端,与滚轮垂直,然后匀速上升,每隔1秒,按打印机一次,共 打印出15~30个数据即可,取打印数据的平均值作为此条样品的剥离强度值。

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The sample aluminum foil surface is fixed to the roller of the tester with double-sided glue. The copper foil is clamped to one end with a clamp, perpendicular to the roller, then rising at a constant speed, every 1 second, press the printer, A total of 15 to 30 data can be printed, and the average value of the printed data is taken as the peeling strength of the sample.

b)注意事项:剥离机上升速度:50mm/min,剥离距离:10~20mm;拉铜箔、 样品与滚轮垂直。Note: machine rise:50 mm/min, stripping distance:10<sup>^</sup> 20 mm; Pull copper foil, samples and vertical roller.

公式计算 Formula to calculate:

拉力 Tensile force(kgf)

剥离强度 Peel strength=

宽度 The width (cm)

注: 以上规范参考 IPC-TM-650, Method 2.4.9. Note: The above specification reference IPC - TM - 650, Method 2.4.9.

#### 焊锡耐热性检验方法 Solder ResistanceTest Method

1. 范围 The range:

本检验方法适用于东溢公司纯胶产品焊锡耐热性之量测。The test method for bonding sheetmeasurement of solder resistance.

- 检测设备 Testing instruments: 锡炉。Wave solder
- 3. 样品制作 The sample:

a) 切取取 10Z 铜箔 10cm×10cm 大小, 切取一块大小相同的纯胶膜, 先铜箔 粗糙面进行贴合, 放在 120℃过塑机上过一遍, 裁切 1cm 宽, 冷却后撕掉涂胶基 材。取一块铝箔与上面 1cm 宽样品贴合, 再放在 120℃过塑机上过一遍。The size of 10Z copper foil 10cm × 10cm was cut and a piece of pure rubber film of the same size was cut. The rough surface of copper foil was first bonded and placed on a 120 °C overplasticizer. The width of 1cm was cut and the coating substrate was torn off after cooling. Take a piece of aluminum foil and attach it to a wide sample of 1cm on top, and put it on a 120 °C plasticizer.

b)快压: 温度 180℃、压力 100kgf/cm2、预热 10s、成型 90s; 熟化: 160 ℃ × 60min; Quick pressure: temperature 180℃, pressure 100 kgf/cm2, Time10 s, 90 s; Cure: 160 ℃ x 60 min.

4. 样品测试The sample test:

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将固化好的样品立即裁成 3cm×3cm 大小三块,用镊子夹住浸入恒温焊锡液中, 焊锡液温度 288℃,每个样品浸锡 10S,然后拿出观察其表面是否有分层或起泡. 以上测试请务必在 5 分钟完成,以防止再次吸湿影响测试结果。The cured samples were immediately cut into three of 3cm×3cm, with tweezers in constant temperature liquid solder, solder liquid temperature is 288℃, each sample dipping 10S, then take out to observe the surface whether delamination or blistering. Please complete the above test must be in 5 minutes, again to prevent moisture absorption effect the test results.

注: 以上参考 IPC-TM-650, Method 2.4.13。Note: The above specification reference IPC - TM - 650, Method 2.4.13.